



# **Dual P-Channel 20-V (D-S) MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}$ ( $\Omega$ )	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
	0.101 at V <sub>GS</sub> = - 4.5 V	- 4.5 <sup>a</sup>			
- 20	0.141 at V <sub>GS</sub> = - 2.5 V	- 4.5 <sup>a</sup>	4.9 nC		
	0.192 at V <sub>GS</sub> = - 1.8 V	- 2			

#### **FEATURES**

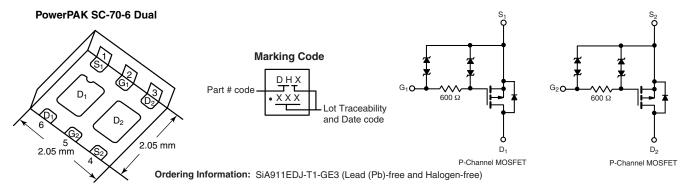
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- New Thermally Enhanced PowerPAK<sup>®</sup> SC-70 Package
  - Small Footprint Area
  - Low On-Resistance
- Typical ESD Protection 4000 V



ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

 Load Switch, PA Switch and Battery Switch for Portable Devices



Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 20			
Gate-Source Voltage	V <sub>GS</sub>	± 8	V		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 25 °C T <sub>C</sub> = 70 °C	L	- 4.5 <sup>a</sup> - 4.5 <sup>a</sup>		
Continuous Diain Current (1) = 130 °C)	T <sub>A</sub> = 25 °C T <sub>A</sub> = 70 °C	I <sub>D</sub>	- 3.6 <sup>b, c</sup> - 2.9 <sup>b, c</sup>	A	
Pulsed Drain Current	I <sub>DM</sub>	- 10			
Continuous Source-Drain Diode Current	$T_C = 25 ^{\circ}C$ $T_A = 25 ^{\circ}C$	I <sub>S</sub>	- 4.5 <sup>a</sup> - 1.6 <sup>b, c</sup>	7	
Maximum Power Dissipation	$T_C = 25 ^{\circ}\text{C}$ $T_C = 70 ^{\circ}\text{C}$	P <sub>D</sub>	7.8 5	w	
waaiiiuiii i owei Dissipatioli	$T_A = 25 ^{\circ}\text{C}$ $T_A = 70 ^{\circ}\text{C}$	, n	1.9 <sup>b, c</sup> 1.2 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature	•	260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	R <sub>thJA</sub>	52	65	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	12.5	16	C/VV	

#### Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. See Solder Profile (<a href="https://www.vishay.com/ppg?73257">www.vishay.com/ppg?73257</a>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 110 °C/W.

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<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 21		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1Β = - 250 μΑ		2.1			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.4		- 1	V	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 8 V			± 100	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1	μА	
		$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 10			Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -2.7 \text{ A}$		0.083	0.101	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -2.5 \text{ V}, I_D = -2.3 \text{ A}$		0.115	0.141		
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 1 A		0.153	0.192	1	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 2.7 A		7		S	
Dynamic <sup>b</sup>							
Total Gate Charge	Q <sub>g</sub> Q <sub>gs</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_{D} = -3.6 \text{ A}$		7.1	11	nC	
iotal Gate Charge		V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.6 A		4.2	6.5		
Gate-Source Charge				0.7			
Gate-Drain Charge	$Q_{gd}$			1.2			
Gate Resistance	$R_g$	f = 1 MHz		600		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			92	140		
Rise Time	$t_r$ $V_{DD} = -10 \text{ V}, R_L = 3.5 \Omega$		200	300			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 2.9 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		700		1100	
Fall Time	t <sub>f</sub>			400	600		
Turn-On Delay Time	Delay Time t <sub>d(on)</sub>			32	50	- ns	
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_L = 3.5 \Omega$		70	105		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 2.9 A, $V_{GEN}$ = - 8 V, $R_g$ = 1 $\Omega$		990	1500	-	
Fall Time	t <sub>f</sub>			410	615		
Drain-Source Body Diode Characterist	cs						
Continuous Source-Drain Diode Current	$I_S$ $T_C = 25 ^{\circ}C$				- 4.5	А	
Pulse Diode Forward Current	I <sub>SM</sub>				- 10	_ ^	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 2.9 A, V <sub>GS</sub> = 0 V		- 0.9	- 1.2	V	

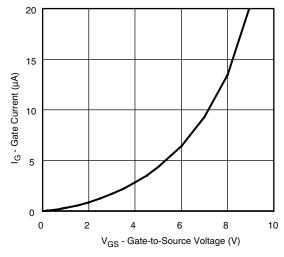
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

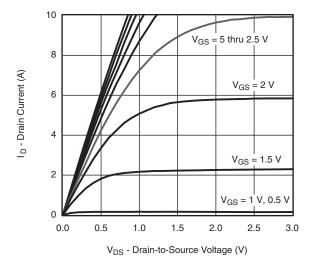
b. Guaranteed by design, not subject to production testing.



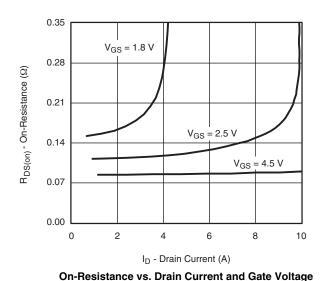
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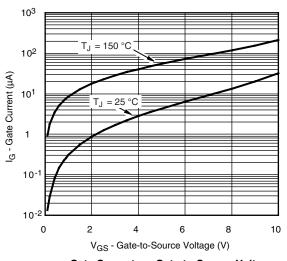


Gate Current vs. Gate-to-Source Voltage

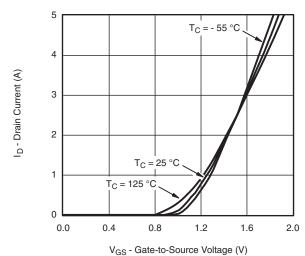


**Output Characteristics** 

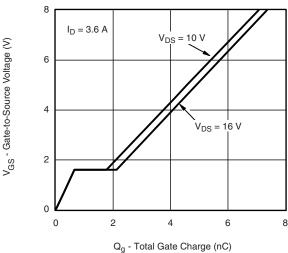




Gate Current vs. Gate-to-Source Voltage



Transfer Characteristics

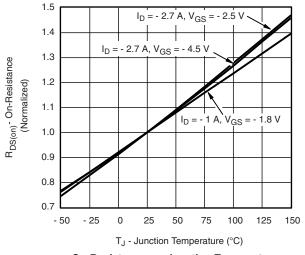


Gate Charge

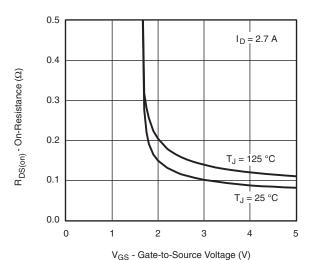
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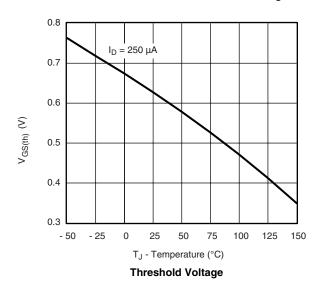
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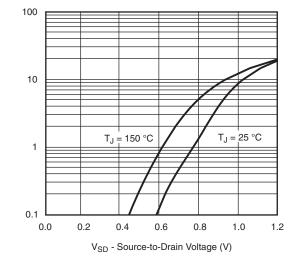


On-Resistance vs. Junction Temperature



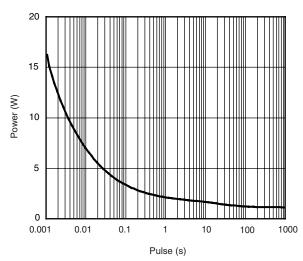
On-Resistance vs. Gate-to-Source Voltage



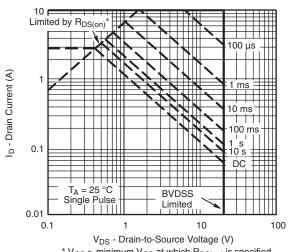


S - Source Current (A)

Soure-Drain Diode Forward Voltage



Single Pulse Power, Junction-to-Ambient

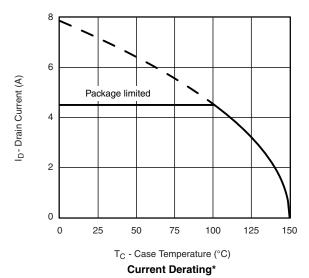


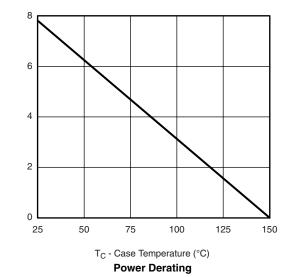
 $^{\star}$   $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





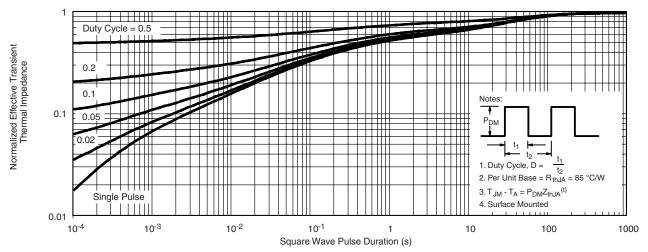
Power Dissipation (W)

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

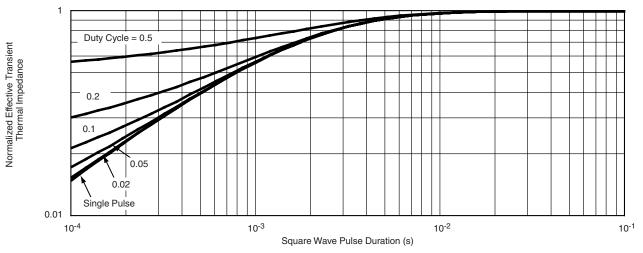
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?68927">www.vishay.com/ppg?68927</a>.



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